

LINEAR TECHNOLOGY MATERIALS DECLARATION

1t1764eq-1.8#pbf

(Engineering Calculation)

DDPAK

(printed on: 2020-07-11 17:33:53)

TOTAL MASS (g) : 1.400321

| COMPONENT MATERIAL | VENDOR/ INDUSTRY NAMES | CONSTITUENT NAME | CAS NUMBER | CONSTITUENT MASS (g) | CONSTITUENT (PPM) OF MATERIAL | CONSTITUENT (PPM) OF TOTAL PKG. | | |
|--------------------------|---------------------------------|--------------------------------|------------|----------------------|-------------------------------|---------------------------------|----------------|----------------------|
| Active Device | Linear Technology | Silicon (Si) | 7440-21-3 | 0.005437 | 1000000 | 3882.6809082 | | |
| Die Coat | Dow Corning | Silicone | 69430-27-9 | 0.000000 | 0 | 0 | | |
| Lead Frame | Cu | Copper (Cu) | 7440-50-8 | 0.852419 | 998500 | 608731.0625 | | |
| | | Iron (Fe) | 7439-89-6 | 0.000000 | 0 | 0 | | |
| | | Phosphorus (P) | 7723-14-0 | 0.000000 | 0 | 0 | | |
| | | Zinc (Zn) | 7440-66-6 | 0.000000 | 0 | 0 | | |
| | | Nickel (Ni) | 7440-02-0 | 0.000000 | 0 | 0 | | |
| | | Silicon (Si) | 7440-21-3 | 0.000000 | 0 | 0 | | |
| | | Magnesium (Mg) | 7439-95-4 | 0.000000 | 0 | 0 | | |
| | | Tin (Sn) | 7440-31-5 | 0.001281 | 1500 | 914.790161133 | | |
| Lead Frame Total: | | | | 0.853700 | 1000000 | 609645.8125 | | |
| Plating | PMI | Exter. Plating Pb | 7439-92-1 | 0.000000 | 0 | 0 | | |
| | | Exter. Plating Sn | 7440-31-5 | 0.009978 | 1000000 | 7125.6640625 | | |
| | | External Plating Total: | | | | 0.009978 | 1000000 | 7125.6640625 |
| | | Inter. Plating Ni | 7440-02-0 | 0.004000 | 740740.75 | 2856.48779297 | | |
| | | Inter. Plating Ag | 7440-22-4 | 0.001400 | 259259.265625 | 999.770568848 | | |
| | | Internal Plating Total: | | | | 0.005400 | 1000000 | 3856.25854492 |
| Die Attach | 95Pb / 5 Sn | Silver (Ag) | 7440-22-4 | 0.000000 | 0 | 0 | | |
| | | Tin (Sn) | 7440-31-5 | 0.000121 | 50000 | 86.4087524414 | | |
| | | Lead (Pb) | 7439-92-1 | 0.002297 | 950000 | 1640.33813477 | | |
| | | Silica (SiO2) | 60676-86-0 | 0.000000 | 0 | 0 | | |
| | | Indium (In) | 7440-74-6 | 0.000000 | 0 | 0 | | |
| | | Metal Oxide | | 0.000000 | 0 | 0 | | |
| | | Antimony (Sb) | 7440-36-0 | 0.000000 | 0 | 0 | | |
| | | Resin (EP) | | 0.000000 | 0 | 0 | | |
| Die Attach Total: | | | | 0.002418 | 1000000 | 1726.74682617 | | |
| Encapsulation | MULTI-AROMATIC RESIN Br/Sb FREE | Resin (EP) | | 0.053704 | 103000 | 38351.203125 | | |
| | | Bromine (Br) | 40039-93-8 | 0.000000 | 0 | 0 | | |
| | | Silica (SiO2) | 60676-86-0 | 0.466653 | 895000 | 333247.125 | | |
| | | Antimony Trioxide (Sb2O3) | 1309-64-4 | 0.000000 | 0 | 0 | | |
| | | Metal Hydroxide | | 0.000000 | 0 | 0 | | |
| | | Carbon Black (C) | 1333-86-4 | 0.001043 | 2000 | 744.829162598 | | |
| | | Encapsulation Total: | | | | 0.521400 | 1000000 | 372343.15625 |
| Bond Wire Estimated | AFW/TANAKA/ Kn | Gold (Au) | 7440-57-5 | 0.001988 | 1000000 | 1419.67431641 | | |
| | | | | | TOTAL MASS (g) : | 1.400321 | | |